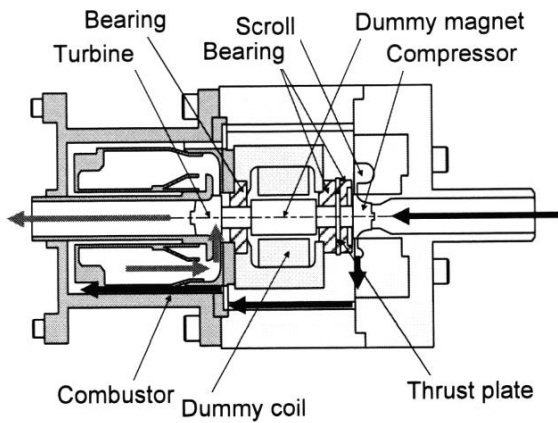
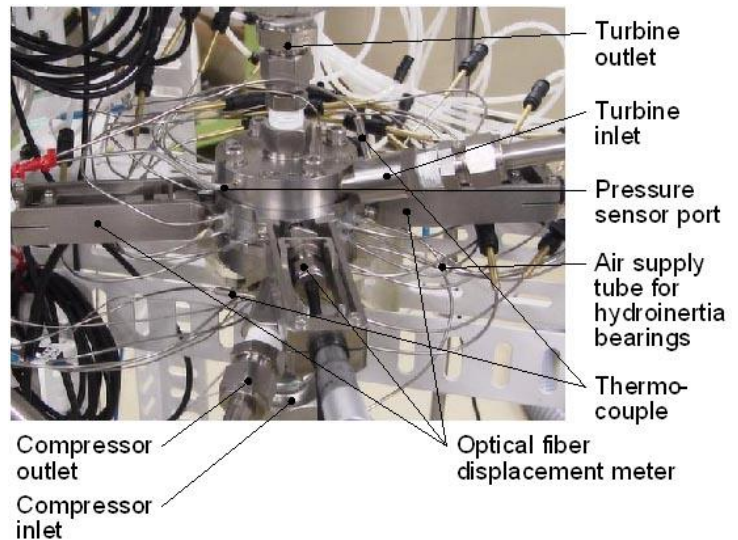
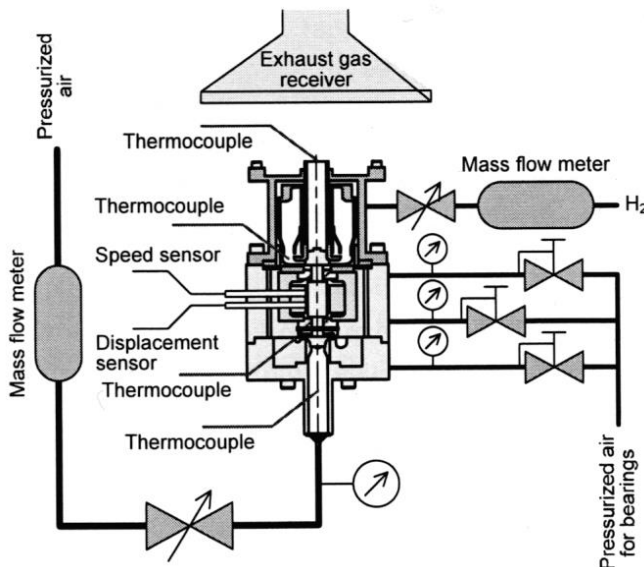


F1 Small size gas turbine engine dynamo



Gas turbine dynamo developed in IHI

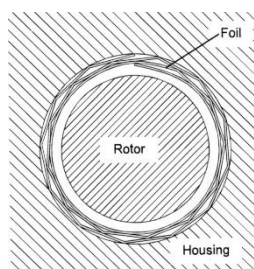
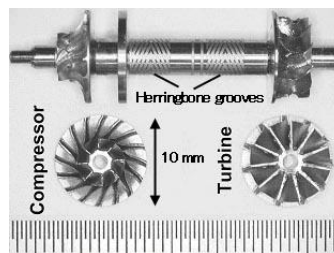


Small gas turbine dynamo (Tohoku Univ. – IHI Corp. – Tohoku-Gakuin Univ. – Tokyo Metropolitan Univ. – The Univ. of Tokyo)
(for outdoor robot etc.)

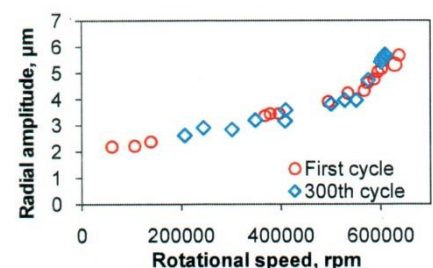
Reference : S.Tanaka, K.Hikichi, S.Togo, M.Murayama, Y.Hirose, T.Sakurai, S.Yuasa, S.Teramoto, T.Niino, T.Mori, M.Esashi and K.Isomura, World's Smallest Gas Turbine Establishing Brayton Cycle, Technical Digest, Power MEMS 2007 (2007) pp.359–362



5 axis stage high speed spindle milling machine used for shaping turbine blade (Toshiba machine F-MACH)

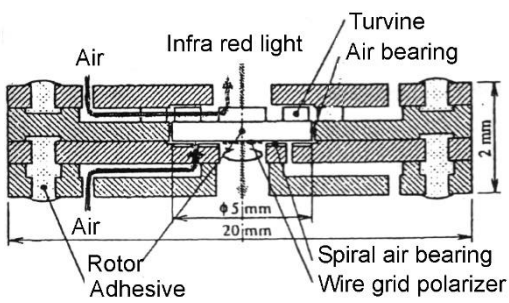


Radial foil bearing (Tohoku Univ. – IHI – Tohoku-Gakuin Univ.)

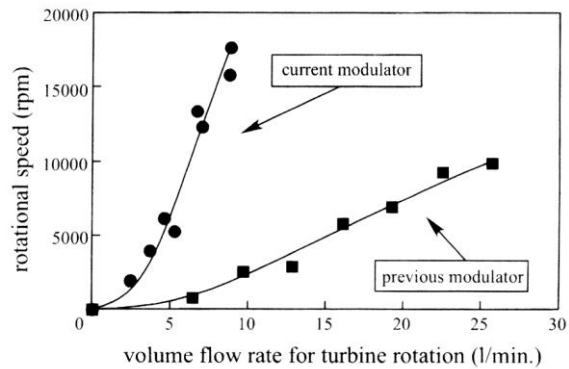


Reference : K.Hikichi, S.Togo, K.Isomura, N.Saji, M.Esashi and S.Tanaka, Ultra-high-speed Tape-type Radial Foil Bearing for Micro Turbomachinery, Technical Digests Power MEMS 2009 (2009) pp.79–82

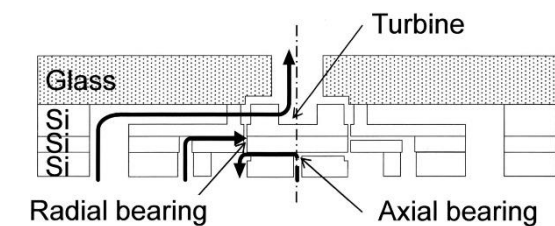
F2 Si micro-turbine and thermoelectric generator



Si air-turbine for high-speed polarization modulator

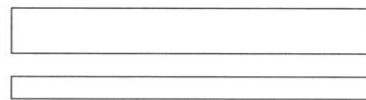


Reference : S.Tanaka, M.Hara and M.Esashi, Mechanical Polarization Modulator Using Micro-turbo Machinery for Fourier Transform Infrared Spectroscopy, Sensors and Actuators, A 96 (2002) pp.215-222

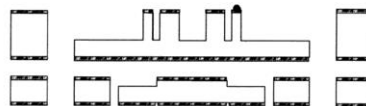


Si air-turbine with radial-inflow type journal bearing

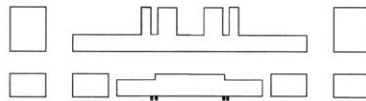
1) Preparation of 2nd and 3rd silicon wafer



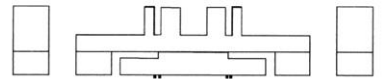
2) SiO₂ deposition, patterning and DRIE



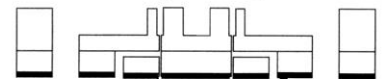
3) SiO₂ etching



4) Direct bonding

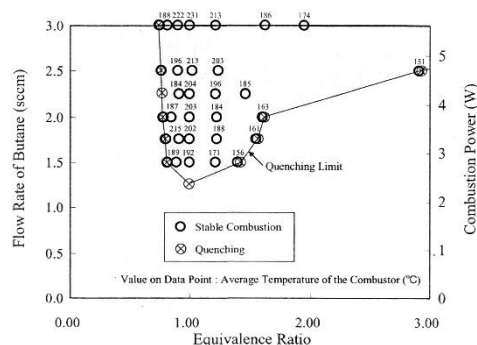
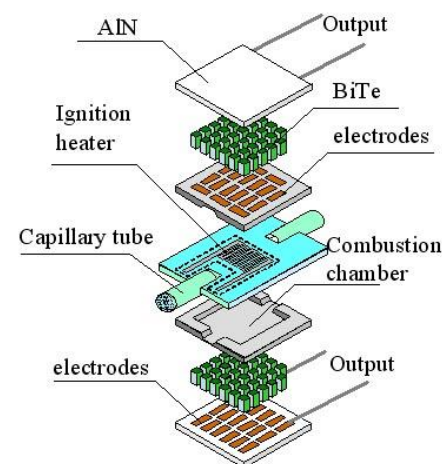


5) Photolithography and cavity-through DRIE

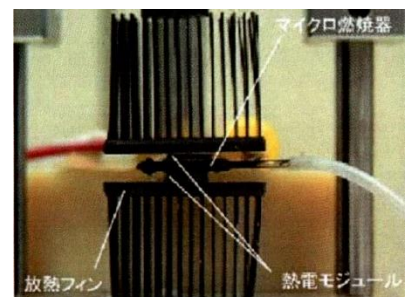
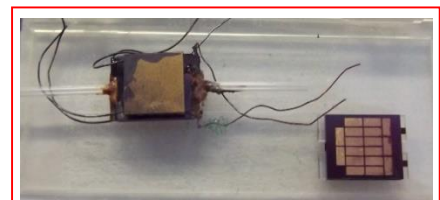


Cavity-through deep reactive ion etching

Reference : S.Tanaka, Y.Miura, P.Kang, K.Hikichi and M.Esashi, MEMS-based Air Turbine with Radial-inflow Type Journal Bearing, Trans. on Electrical and Electronic Engng. 3 (2008) pp.297-304

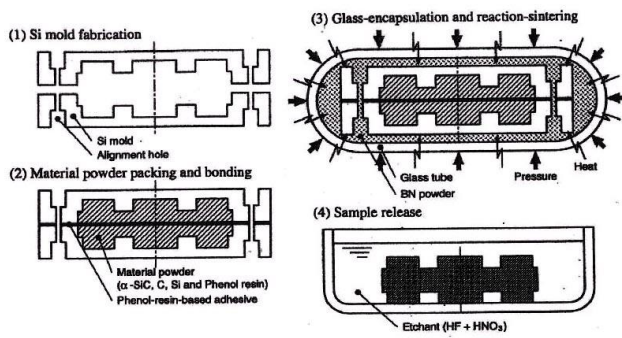


Thermoelectric generator

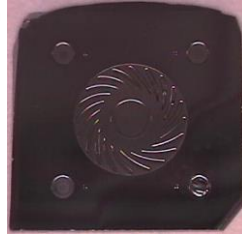


Reference : K.Yoshida, S.Tanaka, S.Tomonari, D.Satoh and M.Esashi, High-Energy Density Miniature Thermoelectric Generator Using Catalytic Combustion, J. of Microelectromechanical Systems, 15 (2006) pp. 195-203

F3 SiC and PZT by lost-mold process, Si₃N₄ by reaction sintering



Fabrication



Si mold

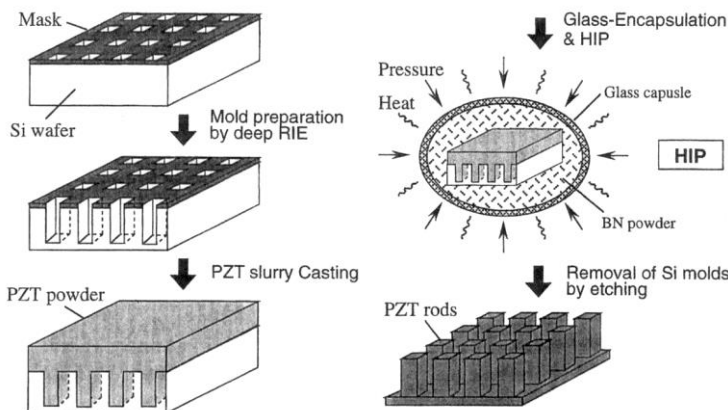


SiC microstructure

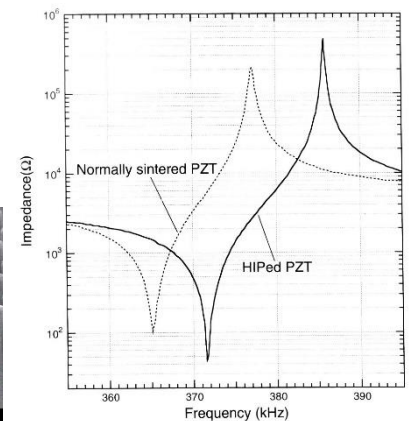


SiC microstructure by lost mold process

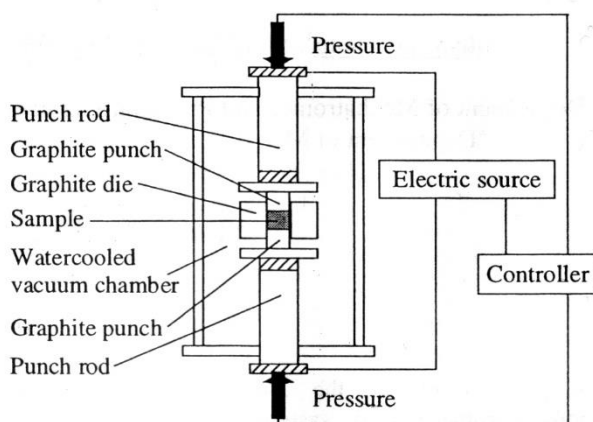
Reference : S.Tanaka, S.Sugimoto, J.F.Li, R.Watanabe and M.Esashi, Silicon Carbide Micro-Reaction
-Sintering Using Micromachined Silicon Molds, J. of Microelectromechanical Systems, 10 (2001) pp.55-61



PZT microstructure by lost mold process



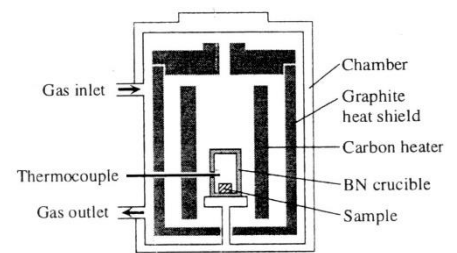
Reference : J.-F.Li, S.Wang, K.Wakabayashi, M.Esashi and R.Watanabe, Properties of Modified Lead Zirconate Titanate
Ceramics Prepared at Low Temperature (800° C) by Hot Isostatic Pressing, J.American Ceramic Soc., 83 (2000) pp.955-957



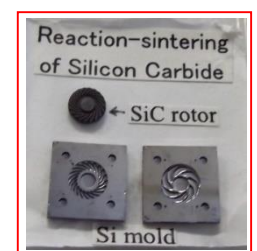
Spark plasma sintering of Si powder



Mechanical shaping



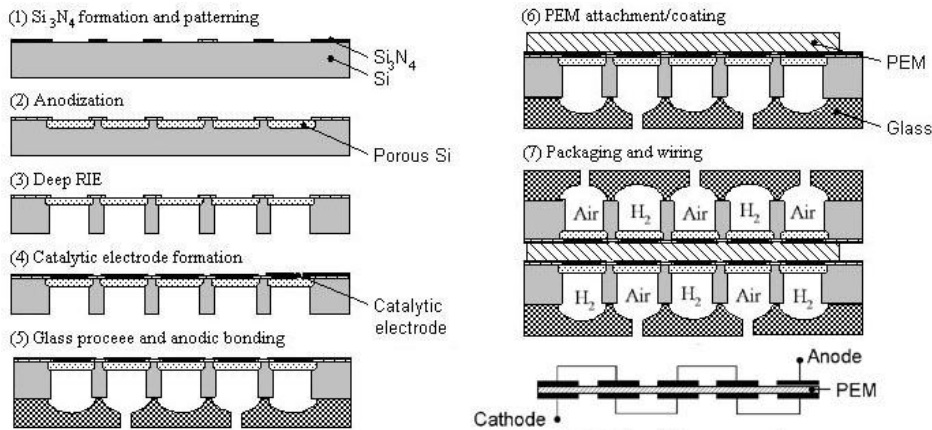
Sintering at 1400°C in N₂ to form Si₃N₄



Si₃N₄ structure by sintering in N₂ of porous Si made by spark plasma sintering of Si powder and mechanical shaping

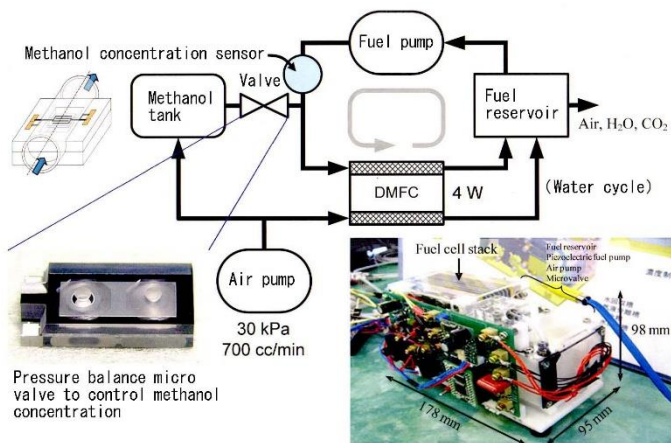
Reference : S.Sugimoto, S.Tanaka, J.-F.Li, T.Yamada, R.Watanabe and M.Esashi, Three-Dimensional Micromachining of Silicon
Nitride for Power Microelectromechanical Systems, Technical Digest of the Transducers' 01 (2001) pp.1140-1143

F4 Micro fuel cell

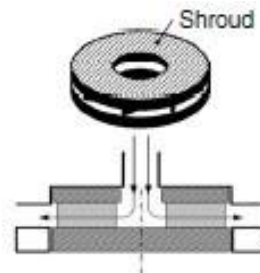


Polymer Electrolyte Membrane (PEM) fuel cell using porous Si as gas permeable membrane

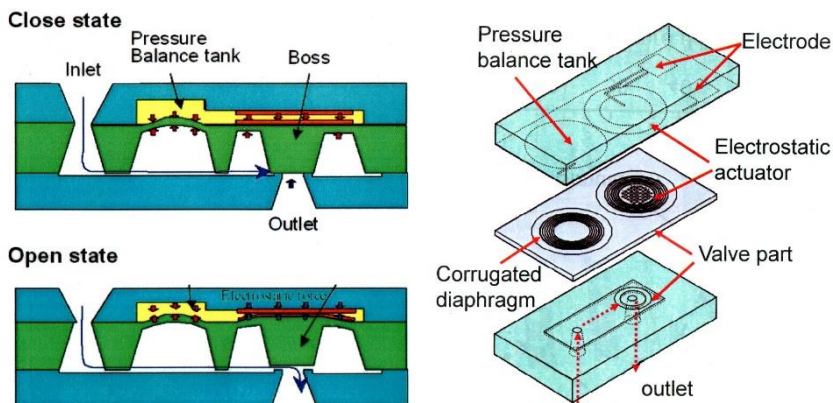
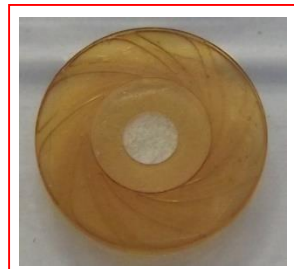
Reference : K.B.Min, S.Tanaka and M.Esashi, MEMS-Based Polymer Electrolyte Fuel Cell, *Electrochemistry*, 70 (2002) pp.924–927



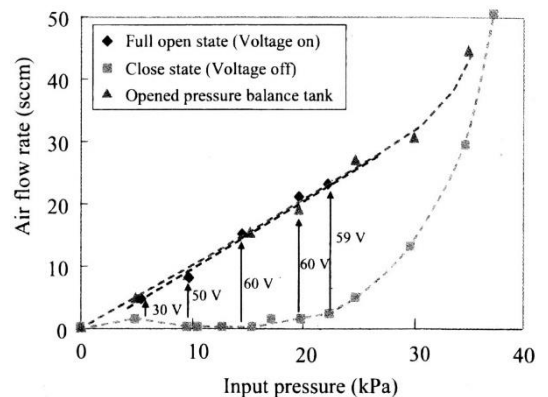
Direct methanol micro fuel cell system
(Tohoku Univ. – Matsushita Electric Works)



Turbo air pump with SU-8 impeller
(Tohoku Univ. – Nippon Kayaku)



Pressure balance type micro valve (Tohoku Univ. – Matsushita Electric Works)



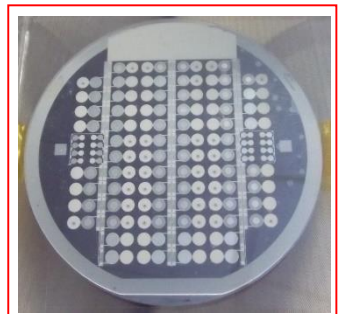
Reference :

S.Tanaka, K.-S.Chang, K.-B.Min, D.Satoh, K.Yoshida and M.Esashi, MEMS-based Components of a Miniature Fuel Cell/fuel Reformer System, *Chemical Eng. J.*, 101 (2004) pp.143–149

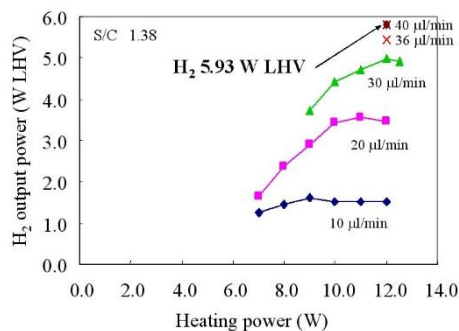
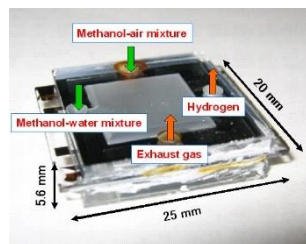
K.Yoshida, S.Tanaka, Y.Hagihara, S.Tomonari and M.Esashi, Normally Closed Electrostatic Microvalve with Pressure Balance Mechanism for Portable Fuel Cell Application, *Sensors and Actuators A*, 157 (2010) pp.290–298

R.Hino, M.Esashi and S.Tanaka, Antisymmetric-mode Lamb Wave Methanol Sensor with Edge Reflectors for Fuel Cell Applications, *Technical Digest MEMS 2010* (2010) pp.871–874

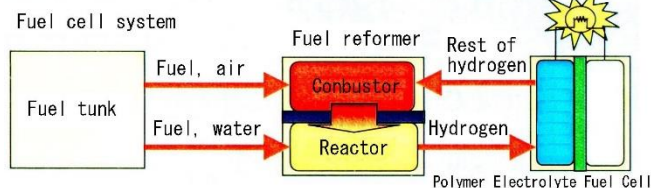
A.Nakajima, P.Kang, N.Honda, K.Hikichi, M.Esashi and S.Tanaka, Fabrication and High-speed Characterization of SU-8 Shrouded Two-dimensional Microimpellers, *J.of Micromech. Microeng.*, 17 (2007) pp.S230–S2



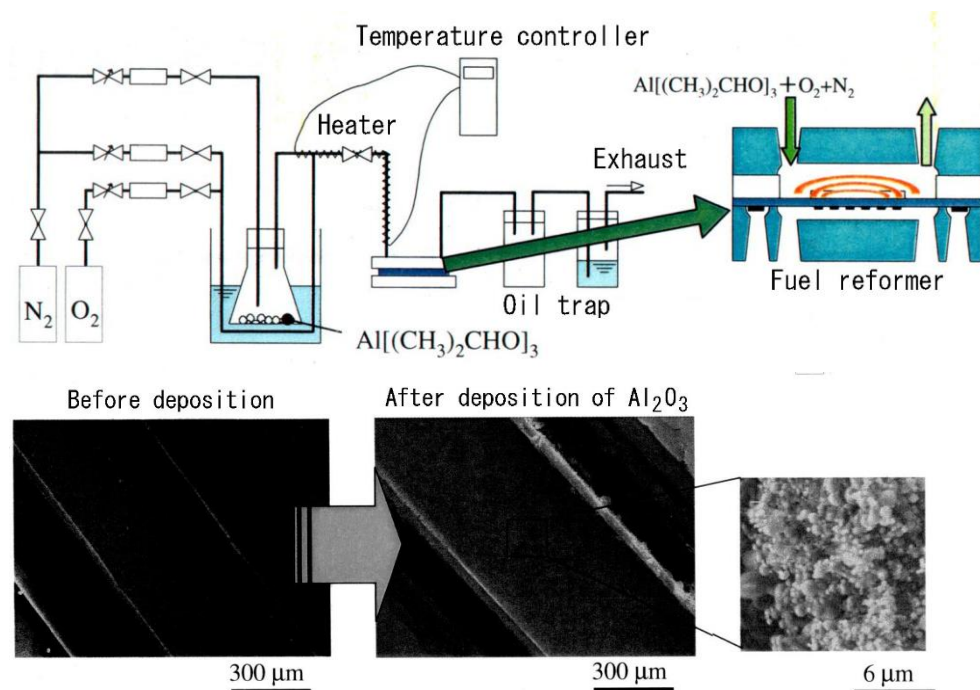
F5 Micro fuel reformer



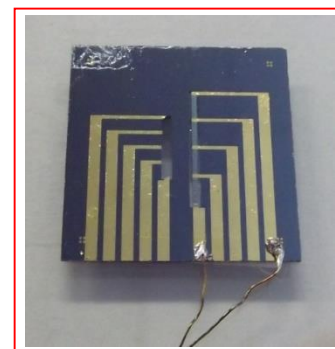
Micro fuel reformer (Tohoku Univ. – Matsushita Electric Works)



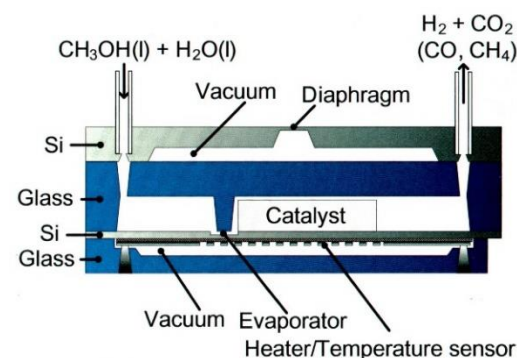
Reference : K.Yoshida, S.Tanaka, H.Hiraki and M.Esashi : A Micro Fuel Reformer Integrated with a Combustor and a Microchannel Evaporator, J.of Micromech. Microeng., 16 (2006) pp.S191–S197



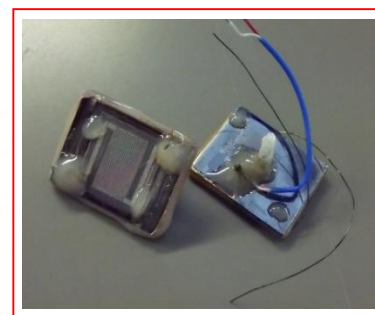
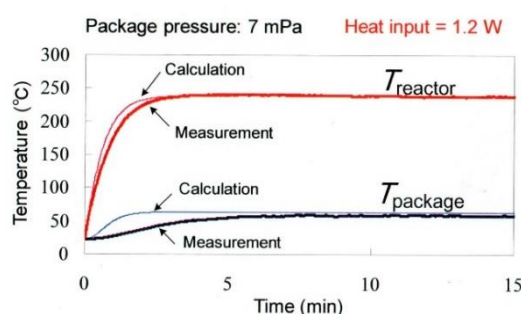
In Situ CVD of catalyst for fuel reformer



Reference : T.Takahashi, S.Tanaka and M.Esashi : Development of an in Situ Chemical Vapor Deposition Method for an Alumina Catalyst Bed in a Suspended Membrane Micro Fuel Reformer, J.of Micromech. Microeng., 16, (2006) pp.S206–S210

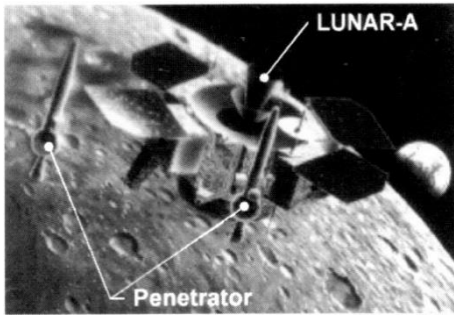


Vacuum-packaged micro fuel reformer

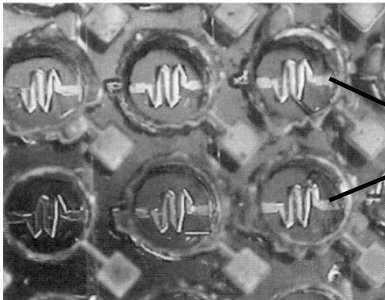
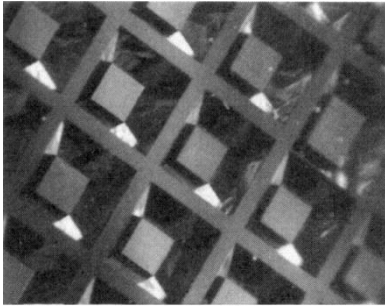
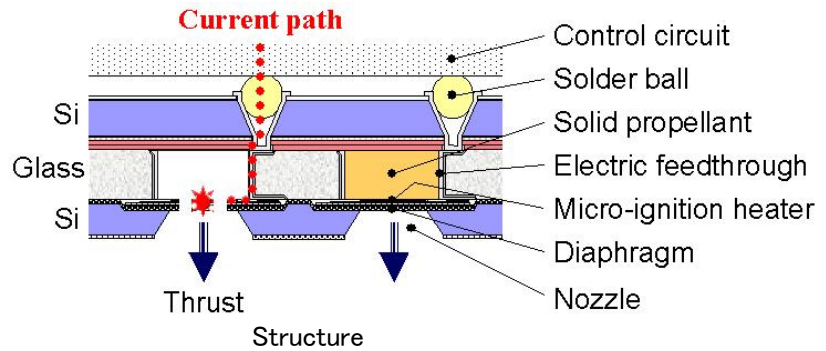


Reference : A.Kasuga, S.Tanaka and M.Esashi, Design and Fabrication of a Vacuum-packaged Micro Fuel Reformer, Technical Digest, Power MEMS 2007 (2007) pp.35–38

F6 Digital micro thruster (solid rocket engine array)

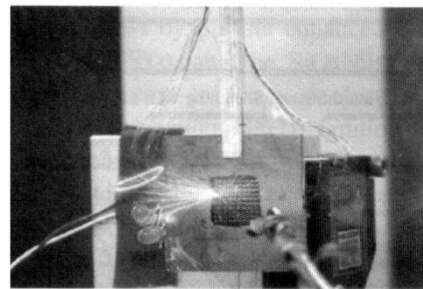
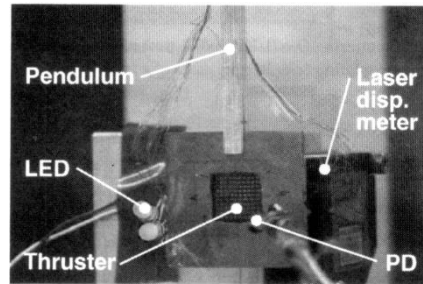


Purpose

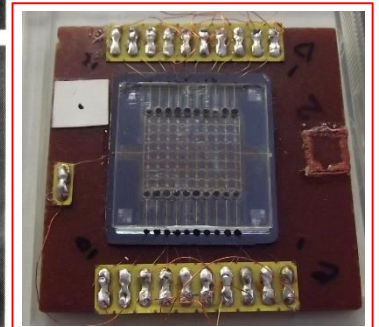


Heater for ignition

Top and bottom sides



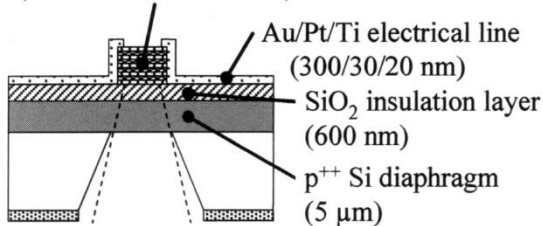
Measurement of thrust force



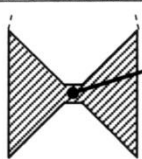
Digital micro thruster (Tohoku Univ. – JAXA)

Reference : S.Tanaka, R.Hosokawa, S.Tokudome, K.Hori, H.Saito, M.Watanabe and M.Esashi, MEMS-Based Solid Propellant Rocket Array Thruster with Electrical Feedthroughs, Trans. Japan Soc. Aero. Space Sci., 46 (2003) pp.47–51

Ti/B/Ti/B/Ti/B/Ti/B/Ti multilayer
(Ti: 250 nm, B: 220 nm)

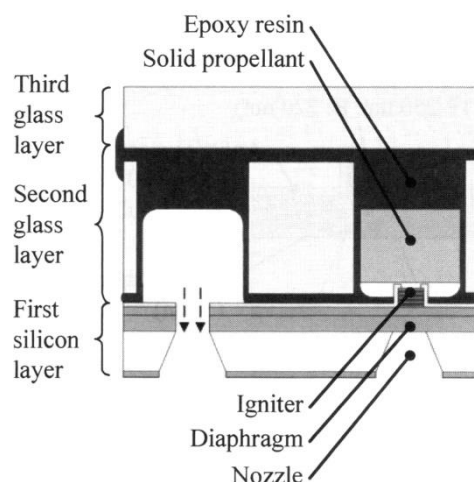


Cross-sectional view

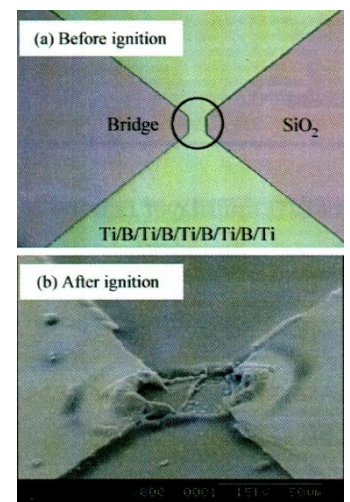


Top view

Bridge
(10 × 10 μm²,
30 × 30 μm²
100 × 100 μm²)

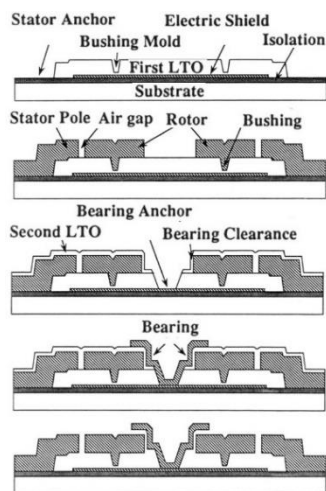


Igniter using a reaction of Bi / Ti (Tohoku Univ. – JAXA)



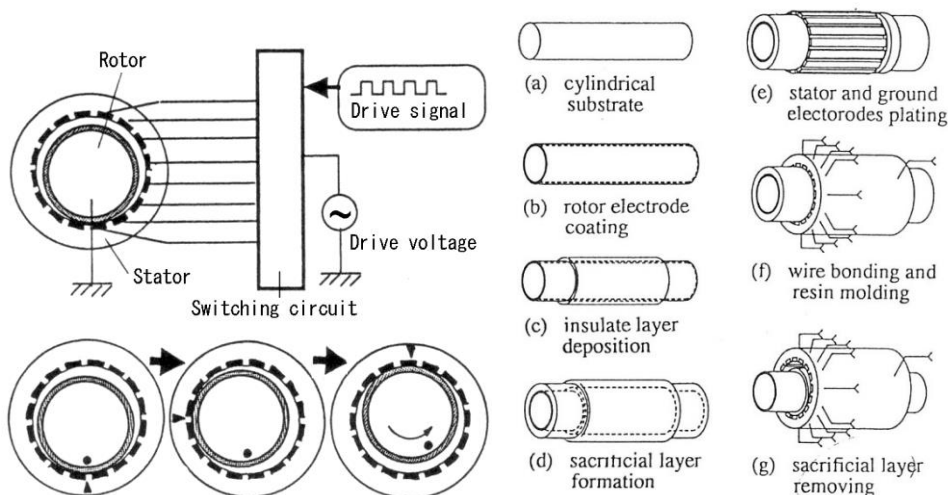
Reference : S.Tanaka, K.Kondo, H.Habu, A.Itoh, M.Watanabe, K.Hori and M.Esashi, Test of B/Ti Multilayer Reactive Igniters for a Micro Solid Rocket Array Thruster, Sensors and Actuators A, 144 (2008) pp.361–366

F7 Electrostatic micro motor, actuator



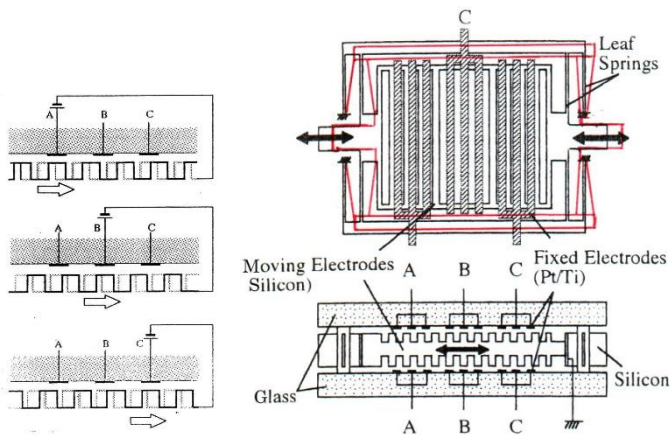
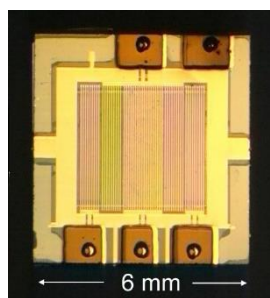
Electrostatic micro motor (MIT USA)

Reference : M.Mehregany, P.Nagarkar, S.D.Senturia and J.H.Lang, Operation of Micro-fabricated Harmonic and Ordinary Side-driven Motors, IEEE MEMS' 90 (1990) pp.1-8

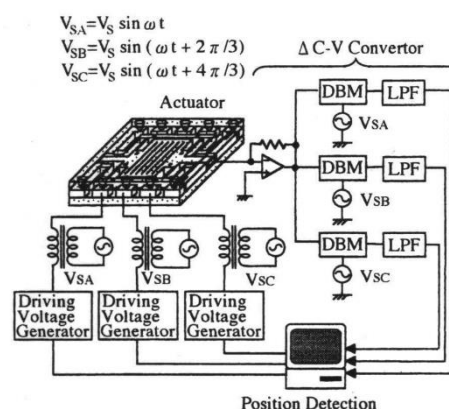
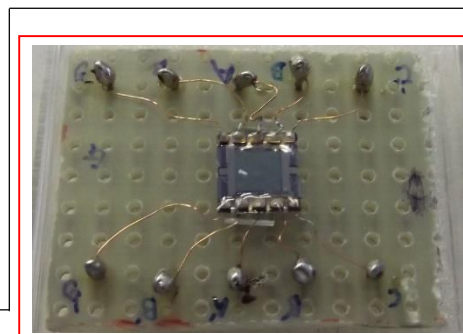
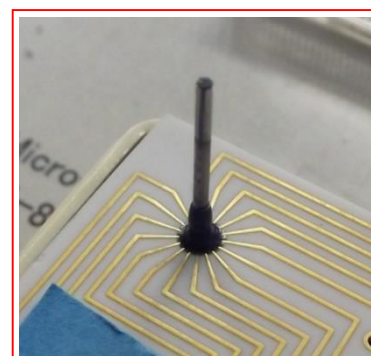
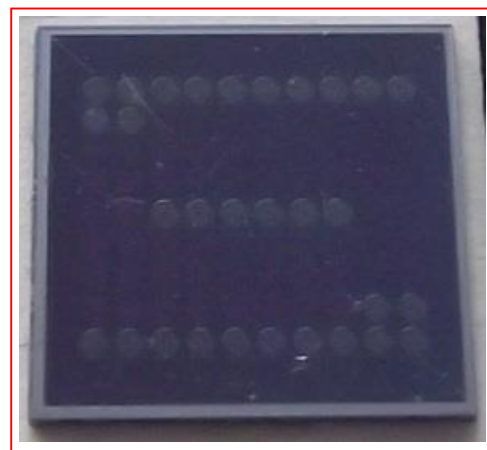


Electrostatic wobble motor (Panasonic Research Institute)

Reference : S.Aoki, H.Ogura, K.Nakamura, A.Ono, A Conventric Build-up Process to Fabricate Practical Wobble Motors, Proceedings IEEE MEMS' 94 (1994) pp.114-118

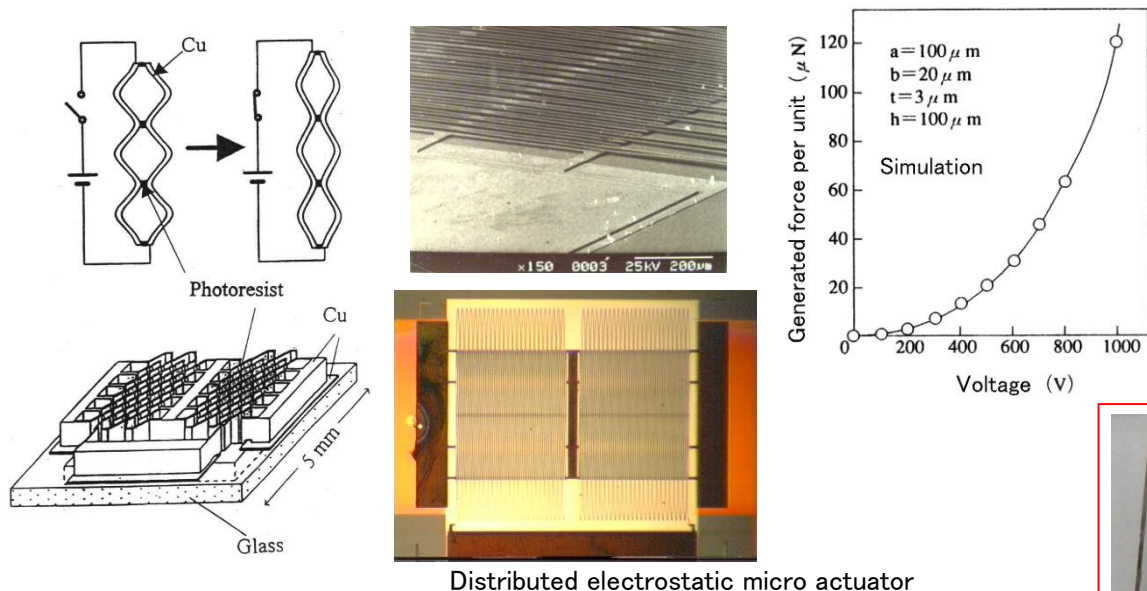


Packaged stepping electrostatic microactuator



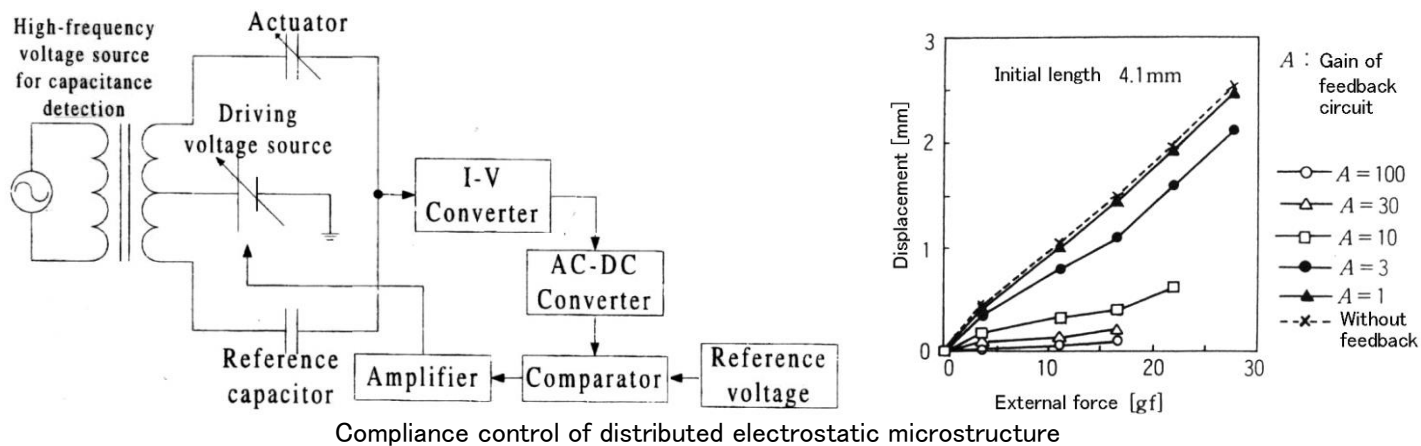
Reference : T.Matsubara, M.Yamaguchi, K.Minami and M.Esashi, Stepping Electrostatic Microactuator, Digest of Technical Papers Transducers'93 (1993) pp.50-53

F8 Distributed electrostatic micro actuator



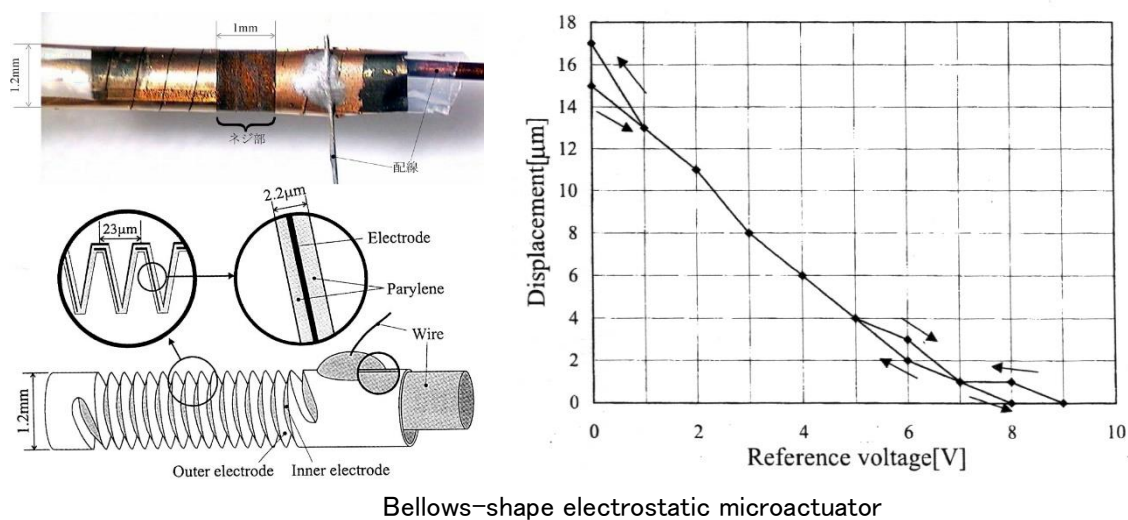
Distributed electrostatic micro actuator

Reference : K.Minami, S.Kawamura and M.Esashi, Fabrication of Distributed Electrostatic Micro Actuator, IEEE Journal of Micromechanical Systems, 2 (1993) pp.121-127



Compliance control of distributed electrostatic microstructure

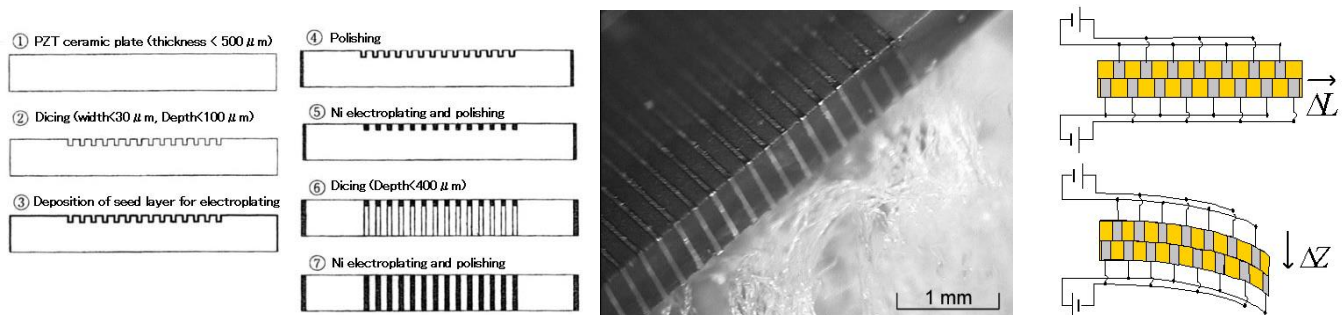
Reference : M.Yamaguchi, S.Kawamura, K.Minami and M.Esashi, Control of Distributed Electrostatic Microstructures, Journal of Micromechanics and Microengineering, 3 (1993) pp.90-95



Bellows-shape electrostatic microactuator

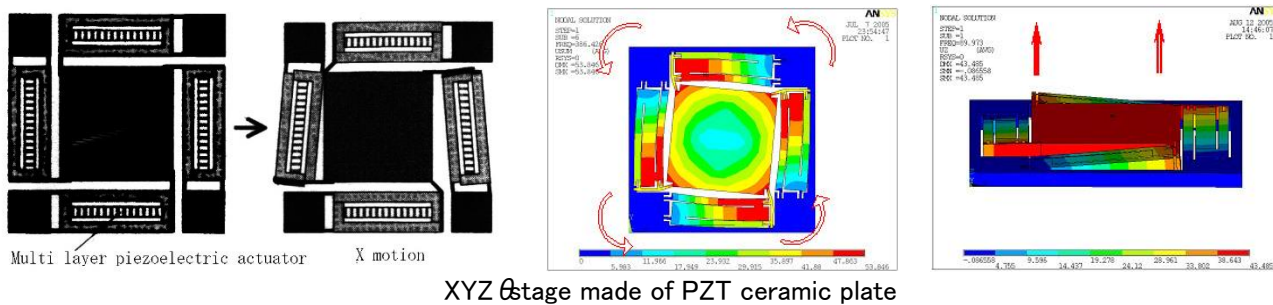
Reference : K.Minami, H.Morishita and M.Esashi, A Bellows-shape Electrostatic Microactuator, Sensors and Actuators, 72 (1999) pp.269-276

F9 Piezoelectric micro stage

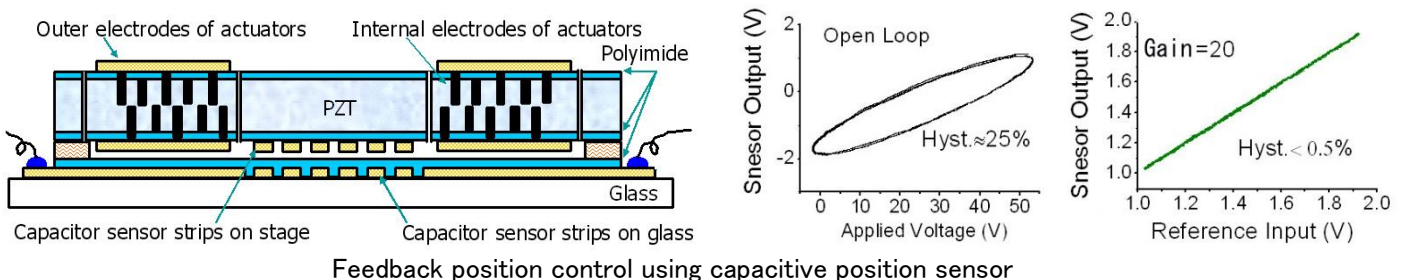


Multi-layer actuator by dicing PZT ceramic plate and filling the groove with electroplated metal

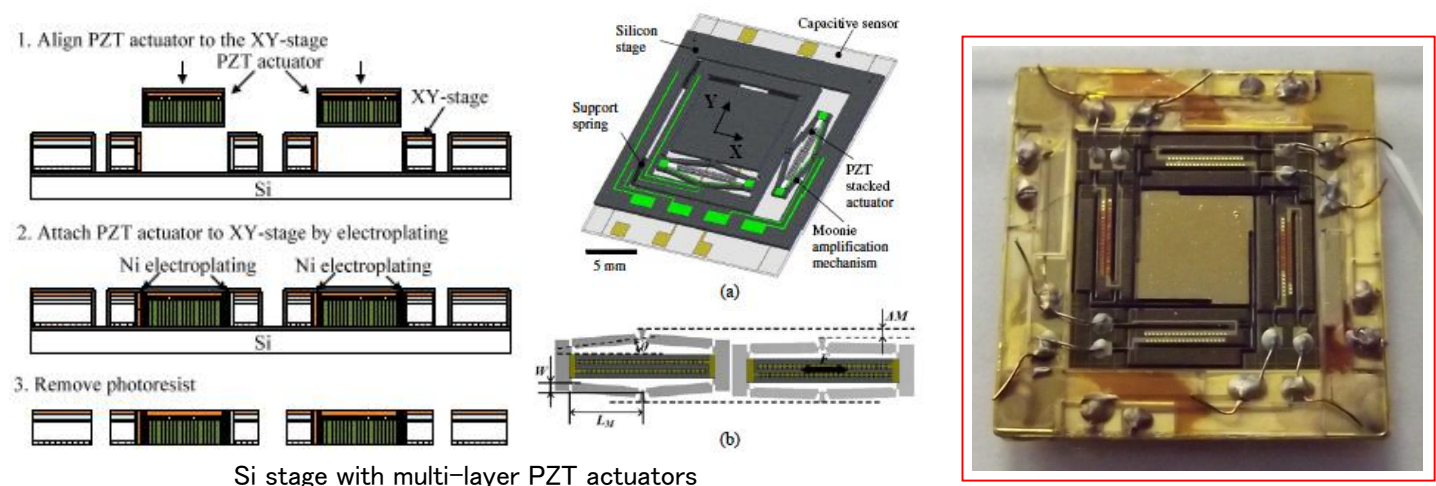
Reference : G.Suzuki and M.Esashi, Planer Fabrication of Multilayer Piezoelectric Actuator by Groove Cutting and Electroplating, Proc. of the Micro Electro Mechanical Systems'2000 (2000) pp.46-51



Reference : D.Zhang, C.Chang, T.Ono and M.Esashi, A Piezodriven XY-microstage for Multiprobe Nanorecording, Sensors and Actuators, A 108 (2003) pp.230-233

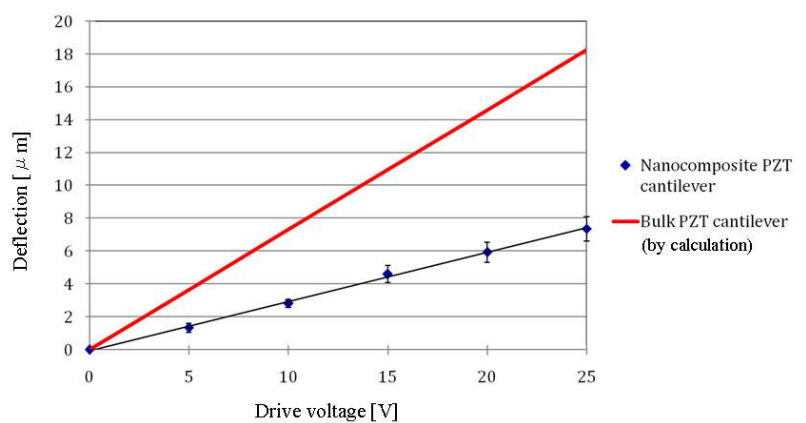
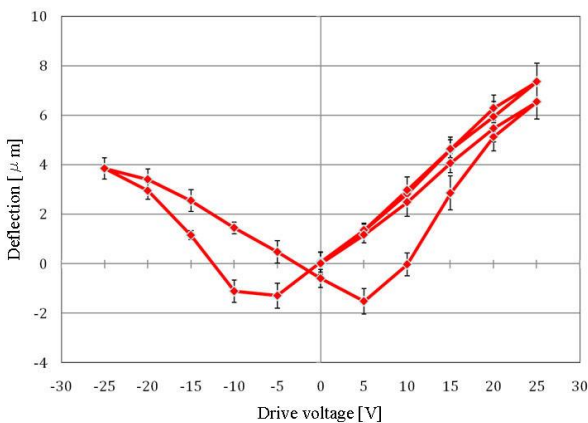
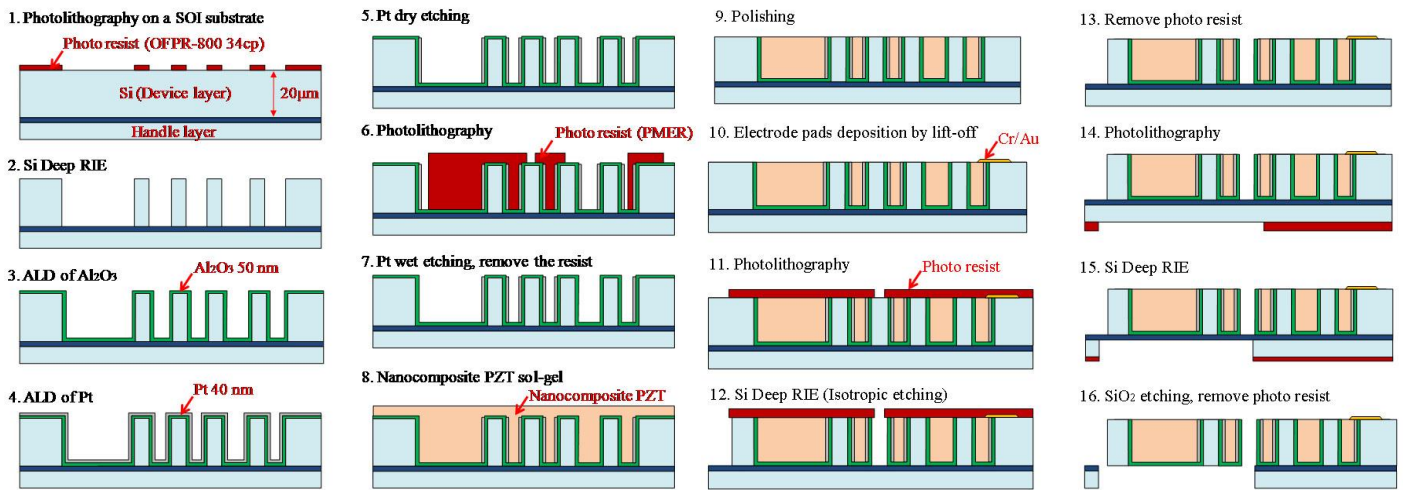
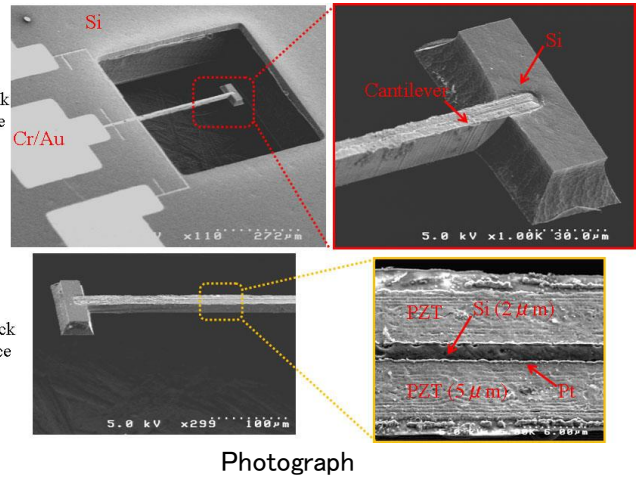
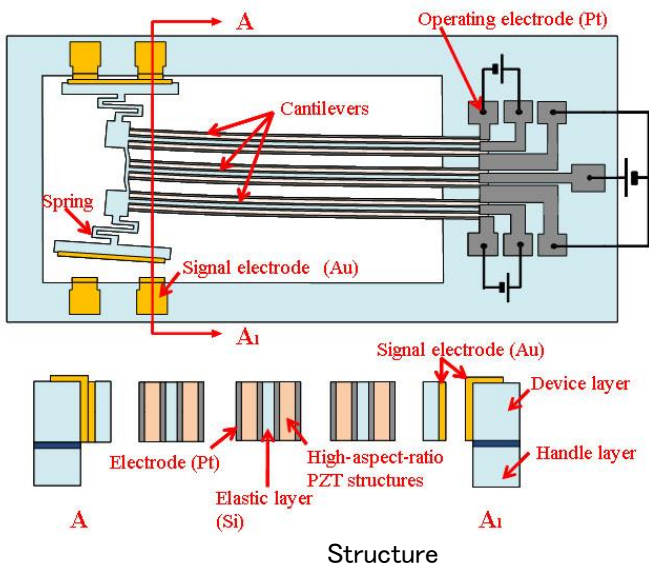


Reference : H.G.Xu, T.Ono and M.Esashi, Precise Motion Control of a Nanopositioning PZT Microstage Using Integrated Capacitive Displacement Sensors, J.of Micromech. Microeng., 16 (2006) pp.2747-2754



Reference : M.Faizul M.Sabri, T.Ono and M.Esashi, Modeling and Experimental Validation of the Performance of a Silicon XY-microstage Driver by PZT Actuators, J.of Micromech. Microeng., 19 (2009) 095004(9pp)

F10 Lateral motion piezoelectric microactuator

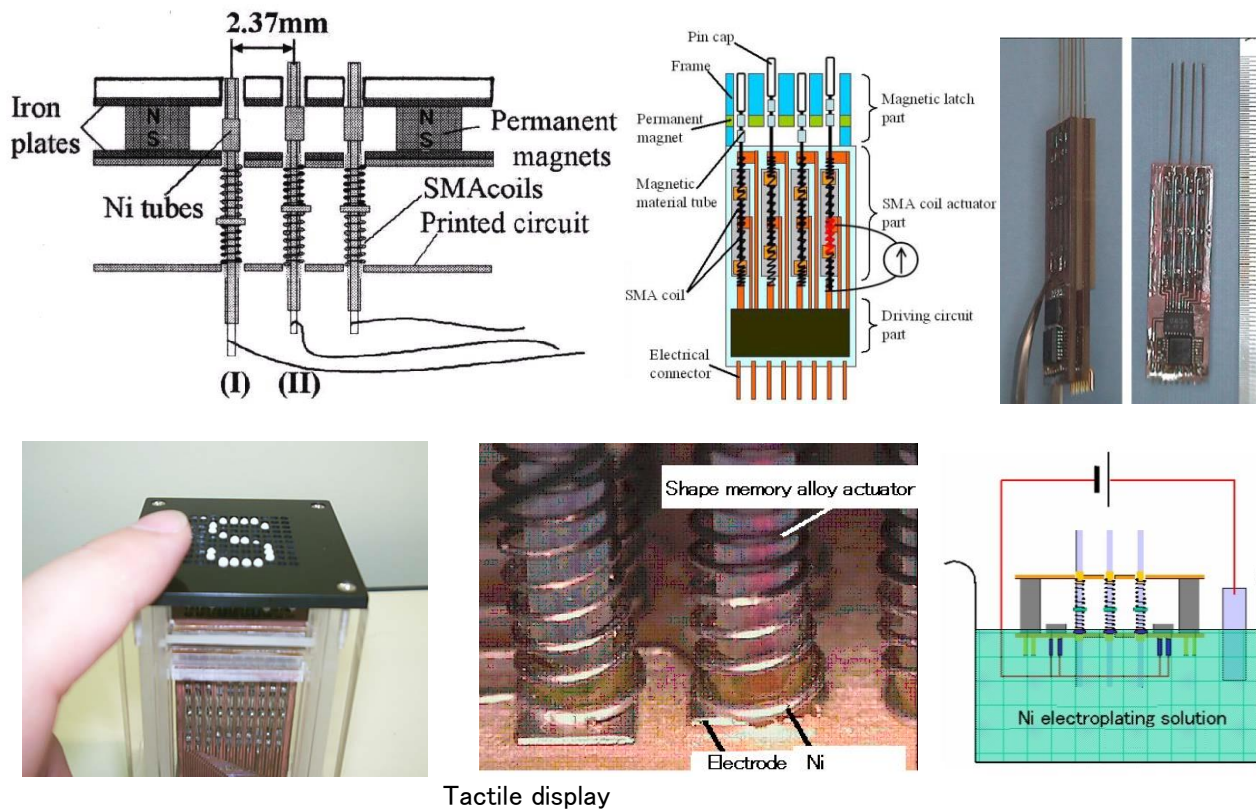


Displacement versus voltage

Lateral motion piezoelectric microactuator

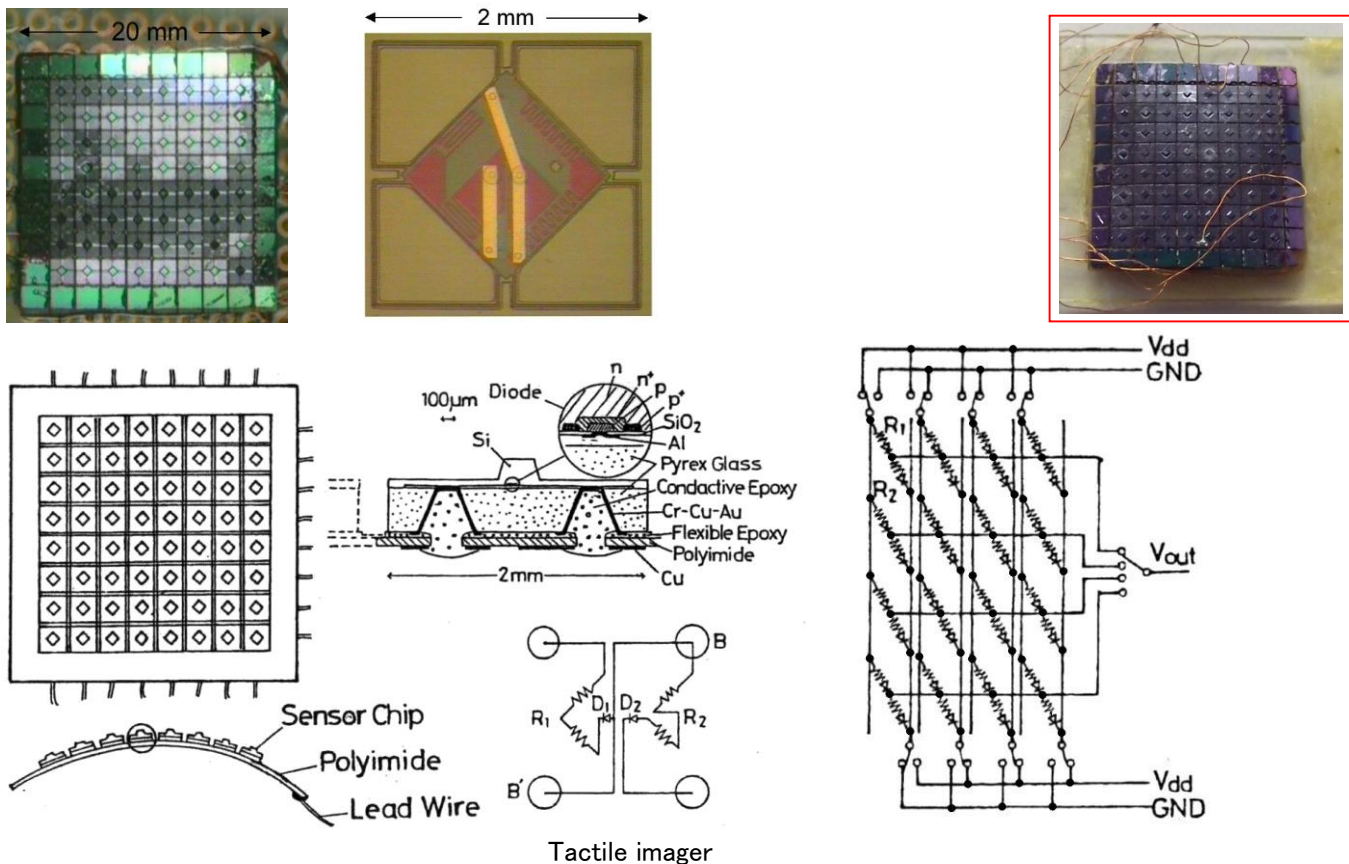
Reference : N.Wang, S.Yoshida, M.Kumano, Y.Kawai and M.Esashi, Fabrication of High-aspect-ratio PZT Structure by Nanocomposite Sol-gel Method for Laterally-driven Piezoelectric MEMS Switch, 2012 7th IEEE Intl. Conf. on Nano/Micro Engineered and Molecular Systems (IEEE NEMS 2012) (2012) pp.321-326

F11 Tactile display and tactile imager



Tactile display

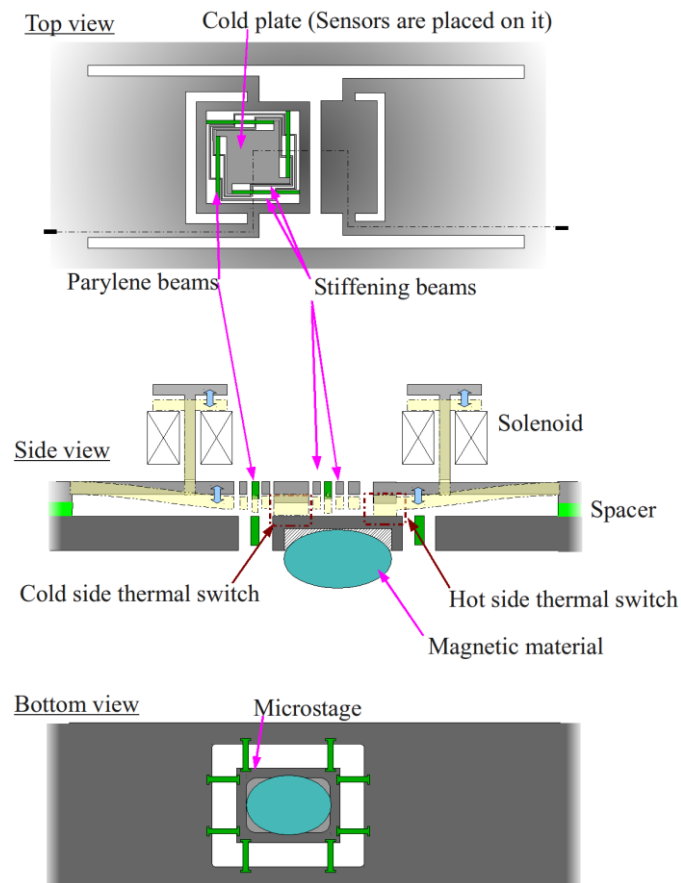
Reference : Y.Haga, W.Makishi, K.Iwami, K.Totsu, K.Nakamura and M.Esashi : Dynamic Braille Display Using SMA Coil Actuator and Magnetic Latch, Sensors & Actuators A, 119 (2005) pp.316-322



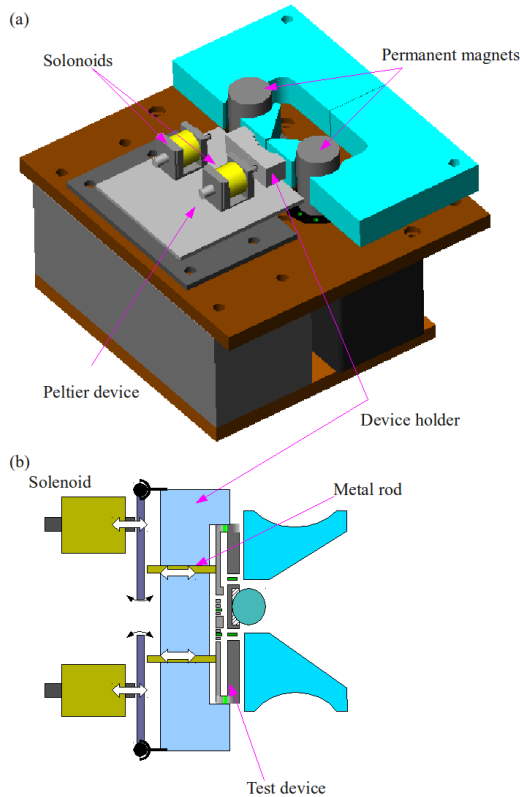
Tactile imager

Reference : M.Esashi, S.Shoji, A.Yamamoto, and K.Nakamura, Fabrication of Semiconductor Tactile Imager, Electronics and Communications in Japan, Part 2, 73 (1990) pp.97-104

F12 Micro refrigeration system



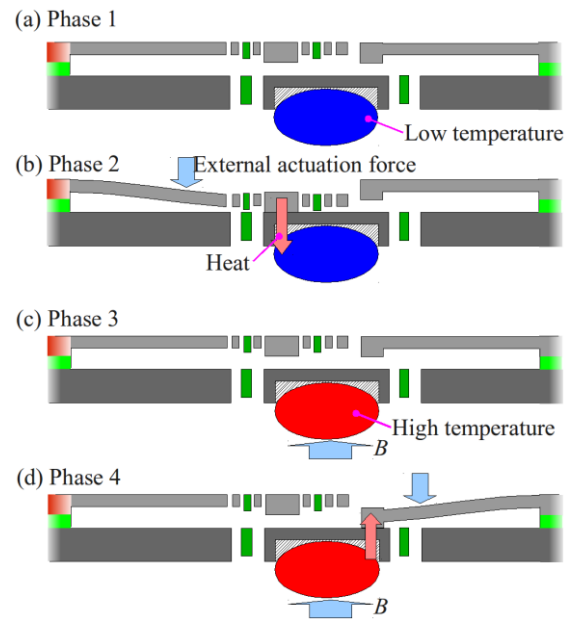
Micro magnetic refrigerator for cooling of micro devices



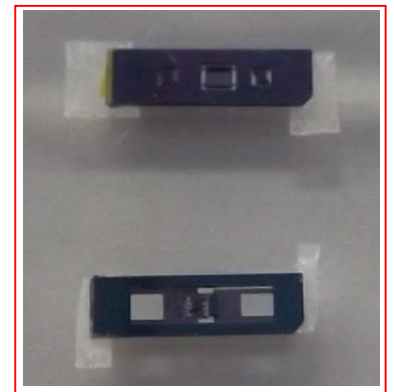
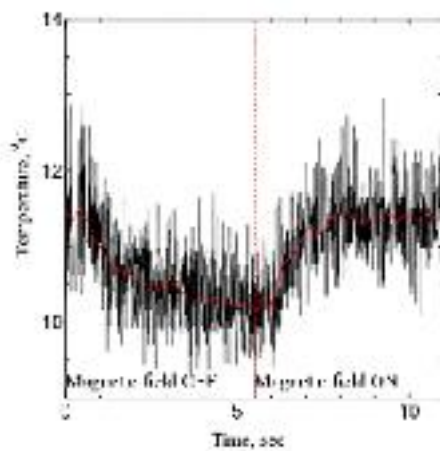
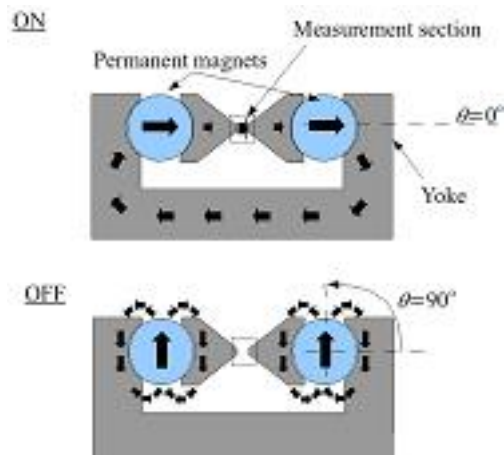
Refrigeration system

Rotating permanent magnets generate modulated magnetic field

Magnetic field induced temperature change of the magnetic material

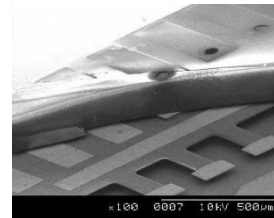
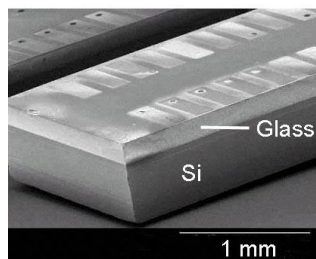
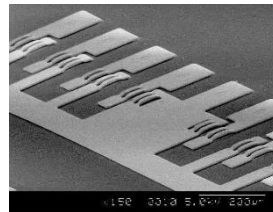
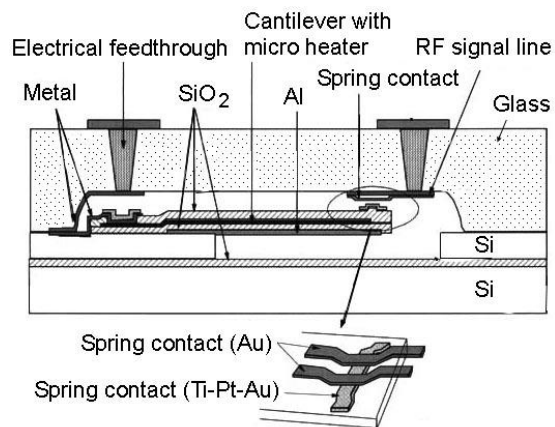


Refrigeration cycle (a)Adiabatic demagnetization (b)Heat dissipation from cold plate (c)Adiabatic magnetization (d)Heat dissipation to ambient.



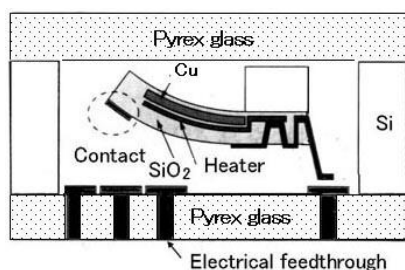
Reference : T.Tsukamoto, M.Esashi and S.Tanaka, A Micro Thermal Switch with a Stiffness-enhanced Thermal Isolation Structure, J.of Micromech. Microeng., 21 (2011) 104008(6pp)

F13 Thermal MEMS switch



Thermal MEMS switch

Reference : Y.Liu, X.Li, T.Abe, Y.Haga and M.Esashi, A Thermomechanical Relay with Microspring Contact Array, Technical Digest IEEE Micro Electro Mechanical Systems'2001 (2001) pp.220-223



Advantages of conventional mechanical switch

- Immune to high voltage
- Excellent isolation at high frequency

Advantages of small size and integration

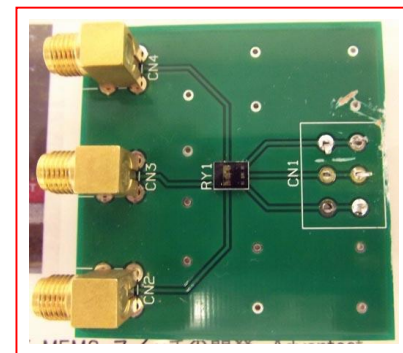
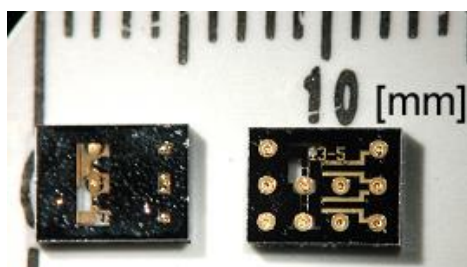
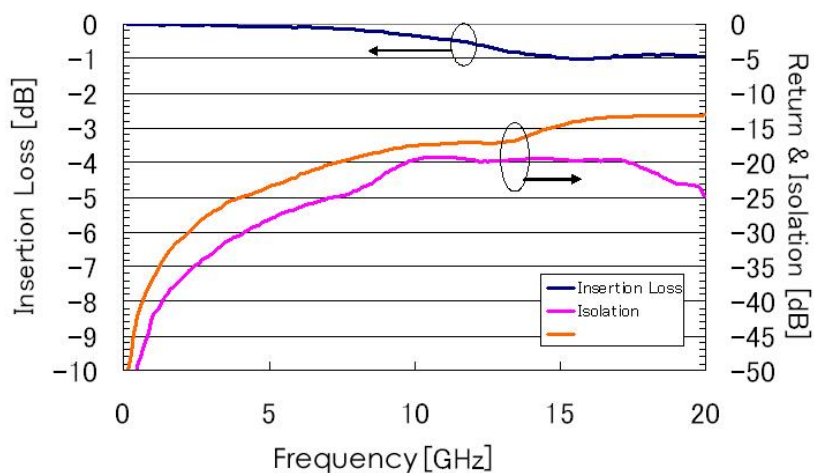
- Wide frequency range

RF MEMS switch

- Immunity to electrostatic discharge : 1000V

- Frequency range : DC - 10GHz

Drive power	<160mW (6V)
On resistance	<0.3 Ω (initial)
Switching speed	<3ms
Contact life	8000 times (3V-15mA dry)



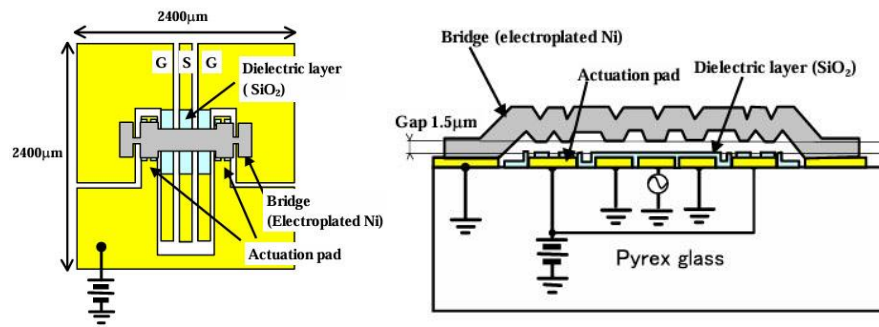
Sol test system T2000



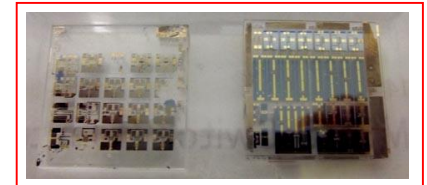
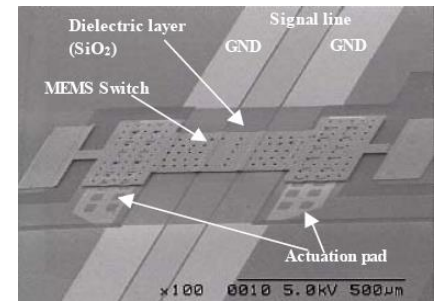
LSI tester using the thermal MEMS switch and Advantest component producing the MEMS switch in Sendai

Reference : K.Nakamura, F.Takayanagi, Y.Moro, H.Sanpeo, M.Onozawa and M.Esashi : Development of RF MEMS switch, Advantest Technical Report, 22 (2004) pp.9-16

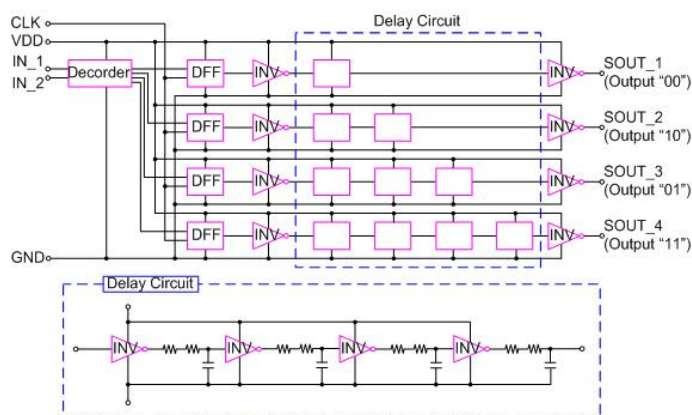
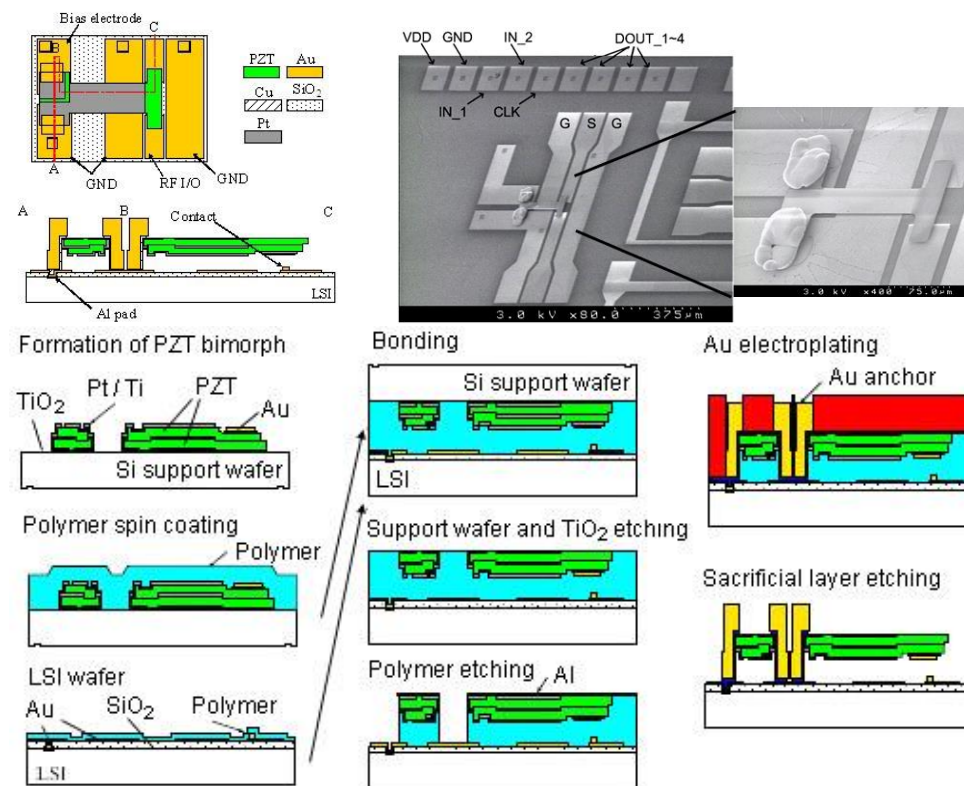
F14 Electrostatic and piezoelectric MEMS switch



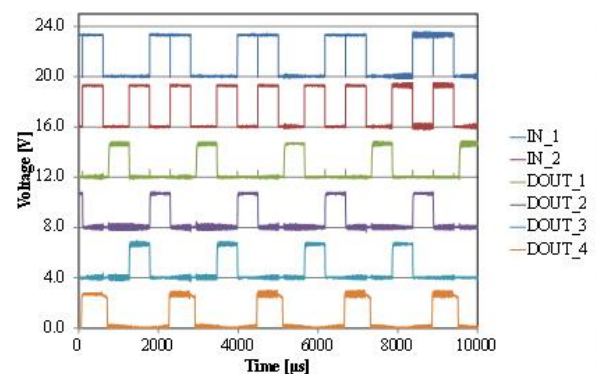
Electrostatically actuated capacitive switch



Reference : T.Yuki, J.H.Kuypers, S.Tanaka and M.Esashi, Capacitive RF Switch Fabricated by Low-temperature Surface Process and Packaged Using Dry Film Resist, Proc. of the 24th Sensor Symp. (2007) pp.37-40



MEMS switch using piezoelectric thin film



Reference : K.Matsuo, M.Moriyama, M.Esashi and S.Tanaka, Low-voltage PZT-actuated MEMS Switch Monolithically Integrated with CMOS Circuit, Technical Digest IEEE MEMS 2012 (2012) pp.1153-1156